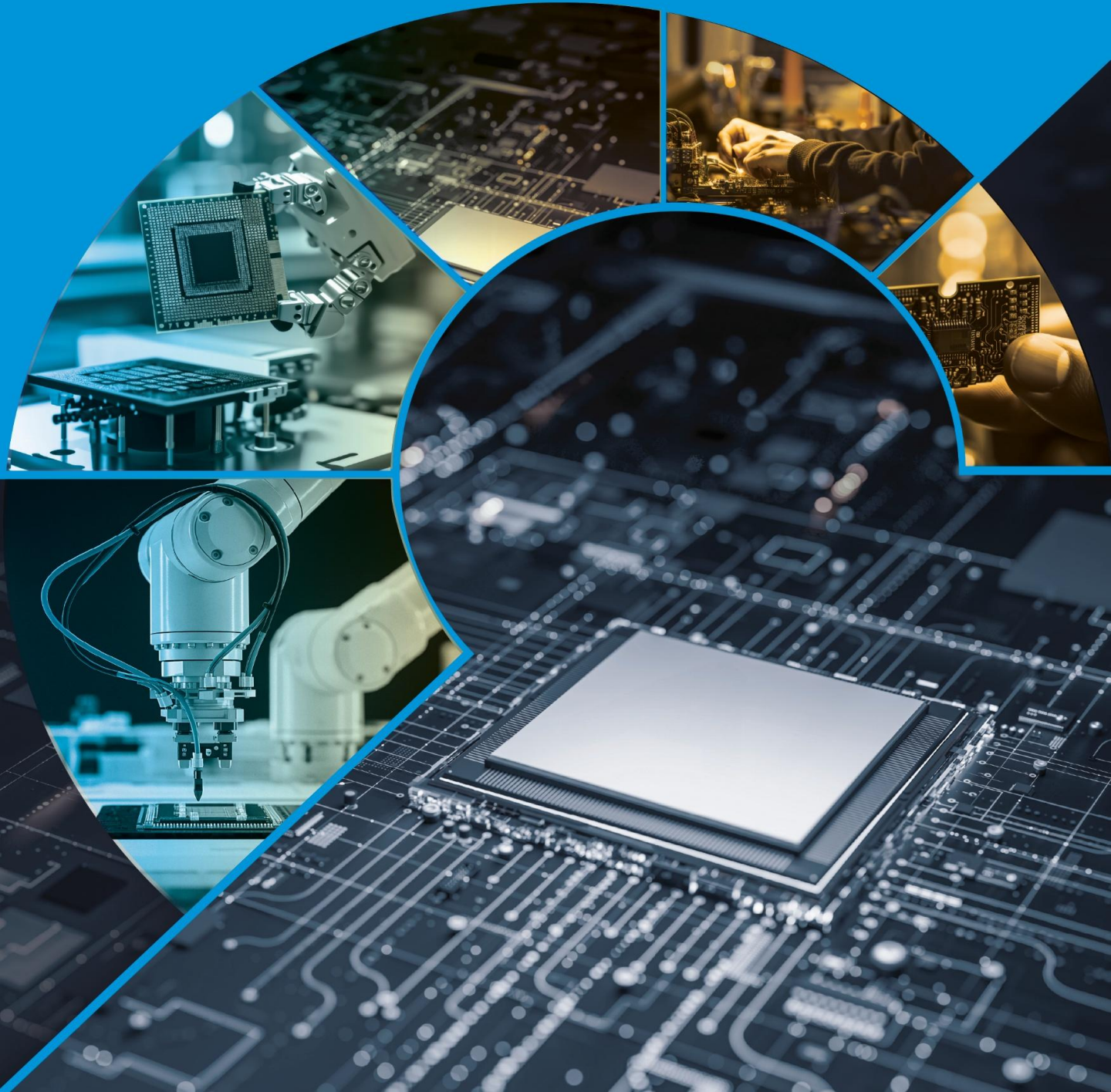
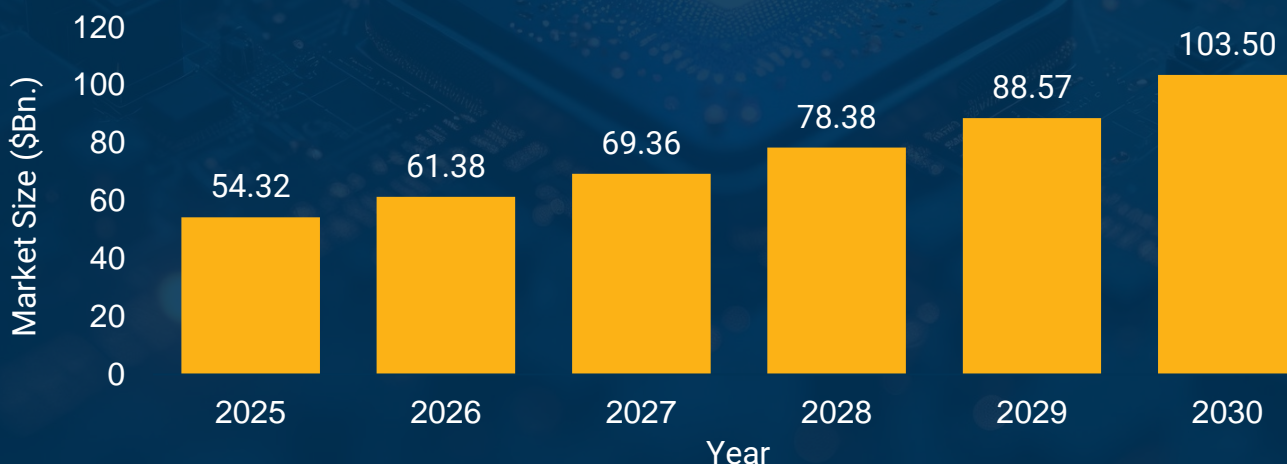


The Chip Catalyst: India's Emerging Semiconductor Ecosystem



Key Market Insights

India's semiconductor sector is transitioning from being a **consumption-heavy market** to becoming a **global capability hub** across design, R&D, and manufacturing enablement. By end of 2025, the industry will be valued at **USD 54.3 Bn.**, and is projected to almost double to **USD 103.5 Bn.** by 2030, at a CAGR of **13.8%** – outpacing global growth benchmarks.



Demand Drivers

Mobile handsets, IT/PCs, and industrial applications will continue to contribute **~70% of revenues**, while **automotive (EVs), 5G infrastructure, and data centers** are emerging as the next multi-billion-dollar growth vectors.



Product Mix

Integrated Circuits dominate (60–64% of revenues), with Discretes (power semiconductors, WBG devices) scaling rapidly in line with India's EV and renewable energy adoption.



Policy Push

The **India Semiconductor Mission** and government-backed projects (₹1.6 lakh crore investments, 29k new jobs) will catalyze the first indigenous semiconductor chip by end-2025.

AI-First Structural Shift



~50% of new SoC programs now include AI accelerators.



~30% of verification teams are piloting ML-driven test and coverage closure.



AI-driven workflows (EDA, firmware, TinyML) are becoming mainstream – placing India at the intersection of **hardware design, AI, and systems engineering**.

Talent & GCC Landscape



India houses **250K+ semiconductor professionals**, with **43K new postings in 2024–25** reflecting accelerating demand.



80% of the workforce has <10 years' experience, signaling depth at junior levels but a leadership supply gap at mid-to-senior roles.



55+ Semiconductor GCCs operate across India, employing 60K+ engineers. These GCCs are evolving from design support to **AI-led system design, verification, and EDA tool development**.

Location Dynamics



Tier-1 hubs (Bengaluru, Hyderabad, NCR) account for **70%+ of the workforce** but face rising attrition and cost escalations.



Tier-2 clusters (Ahmedabad, Mohali, Thiruvananthapuram) are emerging as scalable nodes, supported by **state incentives, ESDM parks, and ATMP initiatives**.

Strategic Takeaways



India is on track to be a global semiconductor talent hub – second only to the US in chip design depth.



AI integration into semiconductor workflows is not incremental; it is reshaping skill requirements, workflows, and GCC mandates.



Tier-1 city saturation necessitates Tier-2 expansion, but scaling leadership talent is the bottleneck.



Government policy alignment with private GCC momentum creates a unique window to accelerate India's end-to-end semiconductor ecosystem.

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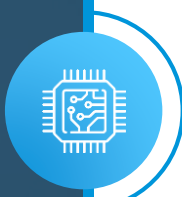
From The Leadership Desk



Market Growth & Device Trends



India's Semiconductor Talent Supply Landscape



India's Semiconductor Skills and roles Composition



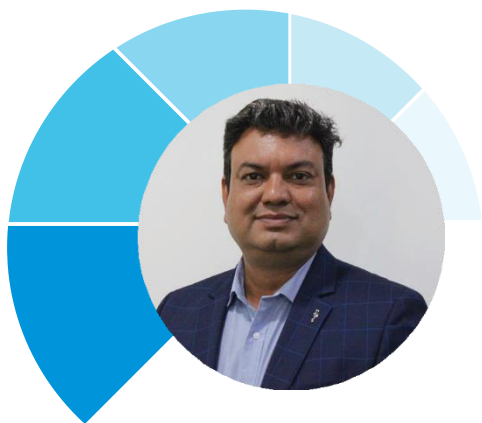
Location level Overlay of Demand Composition



Semiconductor GCC Footprint & Evolution in India



Compensation Trends



KAPIL JOSHI
CEO, QUESS IT STAFFING

From The Leadership Desk

The semiconductor industry is fast becoming a cornerstone of India's Global Capability Centre (GCC) ecosystem. No longer limited to conventional design support, semiconductor GCCs are now driving AI-powered chip development, advanced verification, and end-to-end value creation for leading global players.

By 2025, India's semiconductor market is projected at USD 54.3 Bn., with expectations to almost double by 2030, fueled by strong demand from electric vehicles, 5G infrastructure, data centers, and consumer electronics. This growth is also evident in talent dynamics as India now has more than 250,000 semiconductor professionals, alongside 58,000+ new job postings in 2024–25.

The workforce itself is rapidly evolving. AI-led design workflows, ML-driven verification, TinyML for firmware, and AI-enhanced EDA tools are becoming mainstream. Today, nearly half of new SoC programs incorporate AI accelerators, while one-third of verification teams are experimenting with ML-enabled coverage closure. The industry is no longer confined to chip design alone but thrives at the intersection of hardware, AI, and systems engineering.

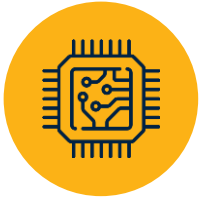
Geographically, Tier-1 hubs like Bengaluru, Hyderabad, and NCR employ over 70% of India's semiconductor professionals but grapple with high attrition and rising costs. Tier-2 cities, including Ahmedabad, Mohali, and Thiruvananthapuram, are gaining traction with government incentives and electronics clusters. However, many advanced design roles in these cities still migrate back to Tier-1 hubs, underscoring the need for better workforce planning and upskilling.

Looking ahead, India's semiconductor growth will be defined not just by scale but by its ability to embed AI readiness, bridge skill gaps, and build resilient innovation-driven talent pools. At Quess IT Staffing, we collaborate with industry leaders to shape this future, helping them attract world-class talent, embrace transformative technologies, and remain competitive in an evolving digital landscape

MARKET GROWTH & DEVICE TRENDS



Market Growth & Device Trends

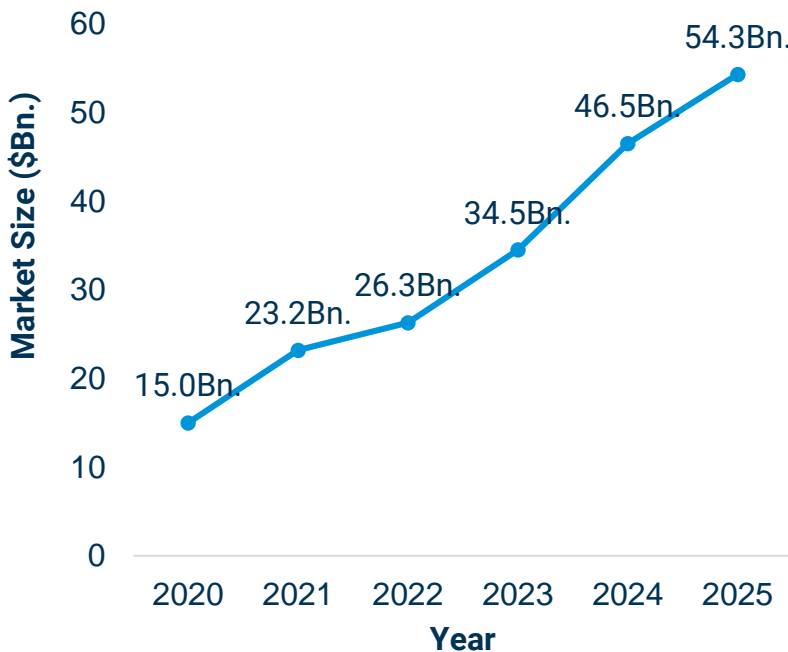


India is no longer just a downstream consumer market, it is becoming a **strategic node in the global semiconductor value chain**. The industry is on track to expand from **USD 15 Bn. in 2020 to USD 54.3 Bn. by 2025**, and **USD 103.5 Bn. by 2030**, outpacing global growth with a **13.8% CAGR**.



This growth trajectory reflects a **structural shift**: global majors are leveraging India not just for **design and verification capacity**, but also for **AI-enabled chip development, advanced EDA workflows, and system-level co-innovation**.

India Semiconductor Market Growth (2020-2025)



Growth Journey (2020-2025)

2020 – Design-led base, Import reliance

2021 – Policy push, PLI incentives announced

2022 – National semiconductor mission launched

2023 – Rising demand, R&D and ATMP growth

2024 – Infrastructure expansion, ecosystem building

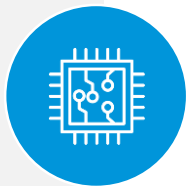
2025 (est.) – Scaling domestic manufacturing

Device-Level Trends



Integrated Circuits (ICs: Logic, Memory, Micro, Analog) – 60-64% revenue share

- **Logic & SoC Design:** Handset processors, AI accelerators, and connectivity chips are central to India's GCC work. Nearly half of new SoC programs globally now include AI/ML accelerators, and India is at the heart of that design activity.
- **Memory:** While wafer fab capacity is offshore, local ATMP investments (Micron in Gujarat) are reinforcing downstream value capture in packaging and testing.
- **Analog:** Analog IC demand - PMICs, BMS, RF/SerDes, will expand in step with EV adoption, telecom base stations, and AI servers. Analog remains a critical design skill gap in India's workforce, with fewer experienced engineers.



Discrete Semiconductors – fastest growth vector

- EV and clean energy rollouts will drive demand for SiC and GaN devices. Globally, SiC is projected to reach ~USD 10 Bn. by 2030 (20-24% CAGR); India's EV target (30% share of vehicle sales by 2030) ensures direct demand linkage.
- **Current weakness:** India does not yet have significant domestic WBG fabs, so reliance on imports will remain high in the medium term.







Sensors & MEMS – small but strategic

- Driven by IoT, wearables, mobility, and ADAS. While base volumes are modest today, sensors will define competitive differentiation in autonomous systems and consumer devices.
- India's strength is more in embedded systems integration than device-level leadership.

Application Growth Vectors – Scale vs Growth

2x2 Framework: Applications by Scale and Growth

Application	Scale Today (2025)	Growth Outlook (2030)	Implications for Global Firms
Consumer Electronics & IT (Smartphones, PCs, Industrial) 	~70% of revenue	Moderate	Still the volume anchor, but cost-driven; India remains critical for design support + embedded software .
5G & Telecom 	High (95% population coverage, 970M+ subs by 2030)	High	Sustained demand for RF front-end, baseband, optical transceivers ; India a key design hub for RF/EDA roles.
Automotive & EVs 	Medium	Very High (EV penetration targets, battery ecosystems scaling)	Requires power semiconductors (SiC/GaN) , BMS, MCUs; global firms must localize talent pools in EV clusters (Ahmedabad, Pune, Chennai).
Data Centers & AI Compute 	Low-Medium	Fastest growth (~77% surge in capacity; India AI GPU/TPU rollouts)	AI compute demand = HBM, accelerators, advanced packaging . India becoming a co-creation hub for AI chip design and firmware .

Additional Sector Insights



India is becoming the epicenter of AI-driven semiconductor design

- With **AI-based verification, P&R, and TinyML firmware**, India's GCCs are no longer "support centers" but **innovation hubs**.
- Firms that do not embed AI-first workflows in their India centers risk **talent irrelevance** within 3–5 years.



Automotive & Power Electronics are the "next big bets"

- As EV adoption scales, demand for **SiC/GaN engineers, analog specialists, and firmware engineers** will outpace supply.
- Early movers in **Tier-2 EV clusters (Ahmedabad, Mohali, Pune)** will gain a **first-mover advantage** on talent costs and ecosystem linkages.



Data Center & AI Compute represent India's fastest demand vector

- India's hyperscale buildout and GPU/TPU rollout will create **sustained demand for high-bandwidth memory, interconnect, and packaging talent**.
- For global firms: This is the opportunity to **co-invest with cloud providers** (Reliance, Tata, Microsoft) in India to secure long-term talent and IP advantages.



Consumer Electronics & Telecom remain the cash cow, but leadership is elsewhere

- These segments will continue to dominate revenue, but growth is tapering.
- Strategic shift: leverage consumer device demand to **fund R&D expansion into EVs and AI compute**.

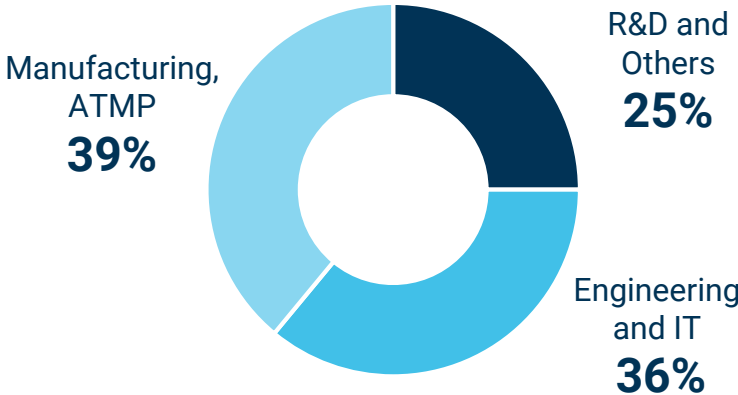
INDIA'S SEMICONDUCTOR TALENT LANDSCAPE



India's Semiconductor Talent Landscape

India hosts one of the largest semiconductor talent pools globally, an estimated 250k professionals in 2025, projected to grow to ~400k by 2030 (+122%). This depth makes India not just a scale market, but a strategic hub for global design and verification capacity.

% split by function of semi conductor Industry (250,000)



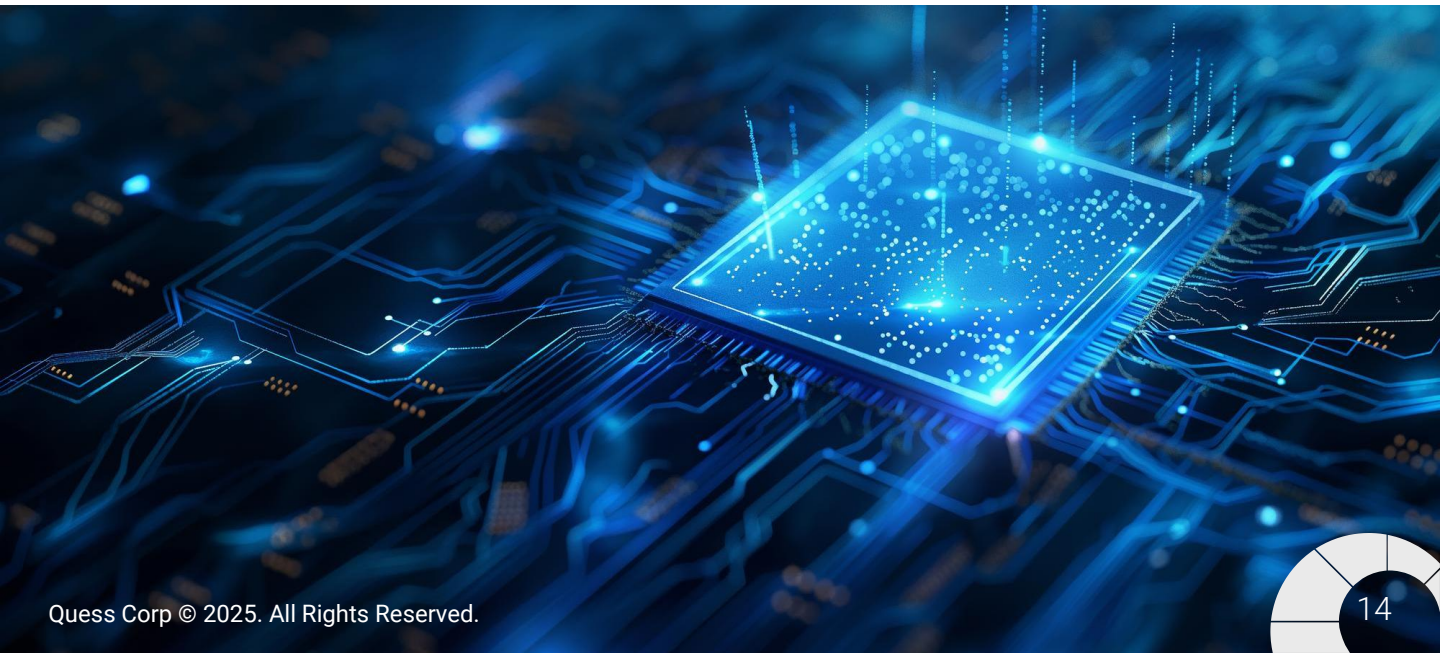
Talent Spread

Cluster	Share of Workforce	Headcount (2025 est.)	Key Hubs	Strengths	Challenges
Tier-1	72%	~1,80,000	Bengaluru, Hyderabad, NCR, Chennai, Pune, Mumbai	Deep GCC ecosystem, global R&D mandates	High attrition, wage escalation, clustering risk
Tier-2	18%	~45,000	Ahmedabad, Mohali, Thiruvananthapuram, Vadodara, Jaipur	State incentives, cost arbitrage, ATMP hubs	Thin leadership pool, advanced roles migrate back to Tier-1
Tier-3	10%	~25,000	Nagpur, Surat, Bhubaneswar, Kochi, Lucknow	Entry-level talent pipelines, strong academic base	Not yet ready for complex design mandates

Location Wise Talent Spread

Tier-1 Hubs – 72% of workforce (~180K professionals)

- **Bengaluru** alone accounts for ~51% of Tier-1, making it the epicenter for global semiconductor R&D.
- **Hyderabad** is scaling fastest in EDA tools, SoC verification, and AI-first chip design.
- **Delhi NCR** contributes 14%, strong in EDA and embedded systems.
- Tier-1 strengths: deep ecosystems, strong GCC presence.
- Weakness: **attrition + rising wage inflation**, especially for mid-senior roles.



Location Wise Talent Spread

Tier-2 Cities – 18% of workforce (~45K professionals)

- **Ahmedabad, Mohali, Thiruvananthapuram** emerging as **design + ATMP hubs**, supported by **state incentives, ESDM parks, and EV/industrial clusters**.
- **Ahmedabad**: linked with Micron’s ATMP facility, strong future for packaging talent.
- **Mohali**: aligned with Chandigarh/Delhi corridor, semiconductor design + industrial electronics.
- **Thiruvananthapuram**: niche in embedded systems and sensors.
- Strength: cost advantage, supportive policy. Weakness: **leadership and advanced design roles still migrate back to Tier-1 hubs**.

Tier 2 locations- 45,000



Implication

Tier-1 saturation and attrition pressure make **Tier-2 scaling critical** for the next decade. Firms that **invest early in Tier-2 talent ecosystems** will benefit from lower costs, state subsidies, and captive talent pipelines.

Location Insights



Bengaluru is the global hub, but fragile on sustainability

- High clustering creates world-class ecosystems, but also **spiraling attrition and compensation wars**.
- Global firms must explore a **hub + spoke model (BLR + Tier-2 city)** to balance depth and costs.



Tier-2 cities are the future scale nodes

- Early investors in **Ahmedabad (ATMP), Mohali (design), Thiruvananthapuram (embedded)** will capture **policy-driven incentives and cost arbitrage**.
- Tier-2 will become essential to **de-risk overdependence on Tier-1 hubs**.



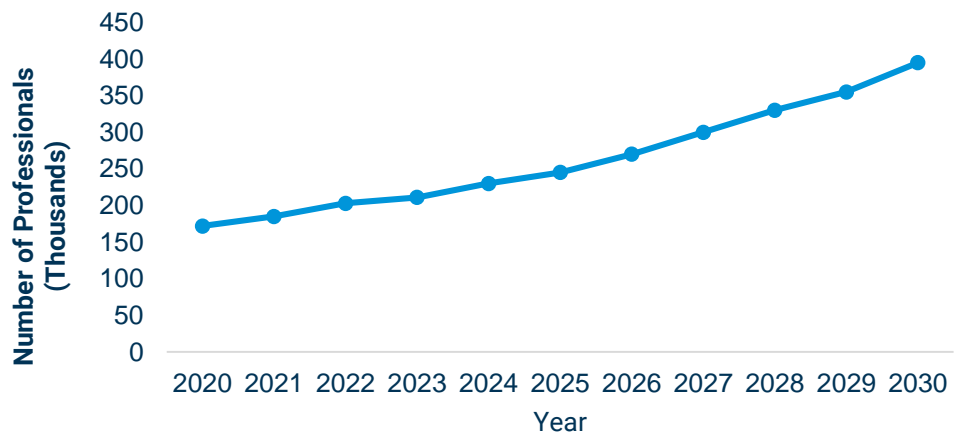
Leadership talent is the missing piece

- While India delivers **execution scale**, global firms struggle to find **senior analog engineers, design architects, and AI-EDA leaders**.
- Leadership development + selective repatriation of Indian diaspora talent are critical levers.

Talent supply growth is real, but uneven

India's semiconductor talent supply is set to grow by ~122% from 2020 to 2030, rising from ~180K to ~400K professionals, driven by government incentives, expanding domestic manufacturing & design capacity, and increased offshoring of chip R&D by global firms.

India Semiconductor Talent Supply (2020-2030)



- Overall pool will expand by **+122% by 2030**, but niche areas (Analog, SiC/GaN, advanced packaging) will face **severe demand-supply imbalance**.

Experience Pyramid



80% of India's semiconductor workforce has <10 years' experience.

- **Strength:** young, adaptable workforce; strong pipeline for design, verification, and embedded roles.
- **Weakness: leadership and specialized domain depth are thin** (only ~20% at mid-senior levels).
- Roles with biggest leadership bottlenecks: **Analog IC, Verification, Physical Design, AI-driven EDA flows.**

Experience Band	% of Workforce	Key Roles	Gaps / Risks
0-5 years	50%	RTL engineers, Verification, Embedded FW, EDA tool developers	Strong execution depth, but prone to attrition
6-10 years	30%	Design Leads, Physical Design Engineers, Validation Engineers	Limited transition to leadership roles
11-15 years	12%	Principal Engineers, SoC Architects	Severe scarcity in Analog IC, Power Electronics
15+ years	8%	Directors, Senior Architects, Functional Leaders	Leadership bottleneck; reliance on expatriates/returnees



Implication

Without a **structured leadership development push**, India risks being “execution-heavy but leadership-light.” This is a critical gap as GCCs scale into AI-first design mandates.

INDIA'S SEMICONDUCTOR SKILLS AND ROLES COMPOSITION



India's Semiconductor Tech Talent Landscape

India's semiconductor Tech industry employs an estimated 120,000 technology professionals engaged in core engineering roles such as chip design, verification, embedded systems development, EDA tool engineering, and system integration.

Key Job Families and Roles Falls Under Tech Semiconductor Industry

 Semi-conductor System Architecture & Design	 Front-End Design & Verification	 Back-End Physical Design & Implementation	 Semiconductor Software, Firmware & Embedded Systems	 Validation, Testing & Product Engineering
Chip Architect / System Architect	RTL Design Engineer	Physical Design Engineer	Embedded Firmware Engineer	Post-Silicon Validation Engineer
SoC Architect	ASIC Design Engineer	Place-and-Route (P&R) Engineer	Device Driver Developer	System Validation Engineer
RTL Design Engineer	FPGA Design Engineer	Timing Closure Engineer	RTOS Engineer	Test Development Engineer
Embedded System Architect	ASIC Verification Engineer	Clock Tree Synthesis (CTS) Engineer	Board Support Package (BSP) Developer	ATE Engineer
Analog/Mixed-Signal Architect	Functional Verification Engineer	Signal Integrity Engineer	Microcontroller Software Engineer	Yield Engineer

Top Job Roles in Tech Semiconductor Industry which has High Growth Rates

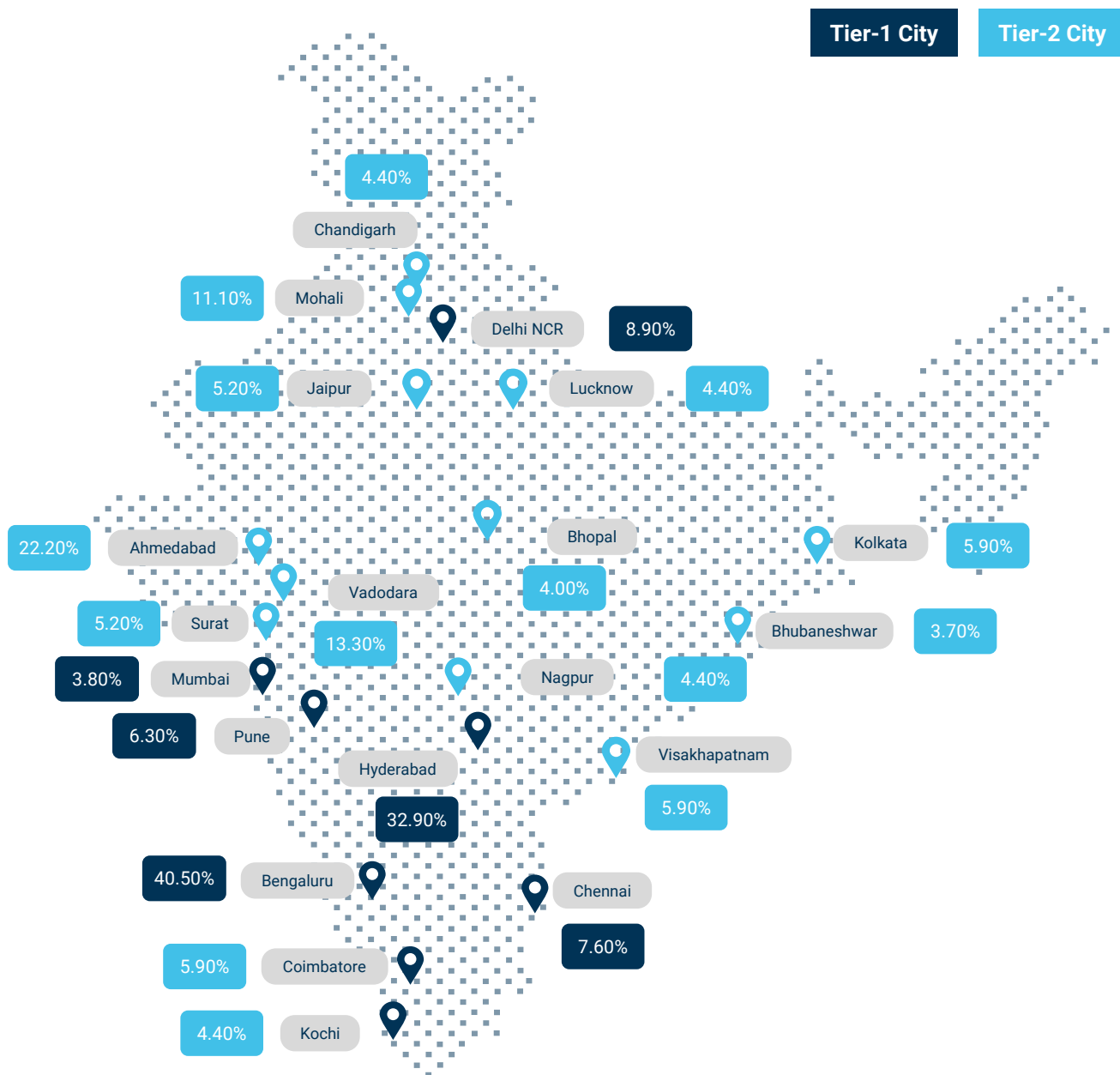
In Demand Job Role	Supply (2025)	Demand (2025)	Job Growth Rate (2025)	Key Skill Clusters
Chip Designer	4,800	750	18%	RTL-to-GDSII integration, NoC/AMBA interconnects, power-performance-area (PPA) trade-offs, multi-power/multi-clock domain handling (DVFS, clock gating), IP integration (PCIe Gen5, DDR5, USB4), formal equivalence checking (Conformal)
RTL Design Engineer	4,200	620	16%	CDC/RDC analysis, UPF/CPF low-power intent, formal verification (JasperGold), synthesis optimization (Synopsys DC), ECO patching at RTL/netlist level, SystemVerilog Assertions (SVA), constraint authoring (SDC)
ASIC Verification Engineer	3,600	580	24%	UVM/OVM methodology, coverage-driven verification (covergroups, coverpoints), constrained-random testbenches, regression automation (Jenkins, scripting in Python/Perl), gate-level simulation with SDF, assertion-based verification (ABV), debug mastery (Verdi, SimVision)
FPGA Design Engineer	2,100	365	20%	FPGA vendor toolchains (Vivado, Quartus, Libero), timing closure in FPGAs, SerDes/high-speed I/O (PCIe, DDR4/5, JESD204B), partial reconfiguration flows, on-chip debug with ILA/SignalTap, custom IP integration, hardware validation using oscilloscopes/analyzers
Physical Design Engineer	3,300	420	17%	Advanced PnR (Cadence Innovus, Synopsys ICC2), MCMC timing closure, EM/IR drop analysis, clock tree synthesis (mesh/H-tree), signal integrity/crosstalk analysis, DRC/LVS sign-off (Calibre, ICV), ECO flows, reliability verification, advanced-node DFM
DFT Engineer	1,600	250	19%	Scan compression (EDT, streaming scan), MBIST/LBIST integration, IEEE 1149.1/1500/1687 standards, test coverage analysis, memory redundancy & repair (fuse programming), production test pattern generation, fault simulation & fault grading (Tessent, Synopsys DFTMAX)
Analog IC Design Engineer	1,900	320	18%	Phase noise/jitter analysis, PLL/VCO design, bandgap/LDO/regulators, SerDes analog front-end design, Monte Carlo & corner modeling, post-layout parasitic extraction (QRC, Quantus), advanced layout techniques (common-centroid, guard rings), mixed-signal interfaces
Embedded Firmware Engineer	6,500	1,200	17%	Device driver stacks (I2C, SPI, CAN, USB, PCIe), secure boot and firmware signing, OTA update frameworks, multi-core SoC bring-up, real-time performance profiling (ETM/ITM trace), debugging with JTAG/SWD tools, middleware integration (Wi-Fi, Bluetooth stacks), low-power firmware optimization

LOCATION LEVEL OVERLAY OF DEMAND COMPOSITION



Location level Overlay of Demand Composition

The vast majority of captive chip-design/EDA teams and leadership roles are concentrated in Bengaluru and Hyderabad creating higher posting velocity and rehiring cycles. Tier-1 absorbs ~70–75% of demand, while Tier-2 (~20–25%) reflects ATMP/industrial-electronics hubs (Ahmedabad–Vadodara–Mohali).



Top in Demand Tech Job Roles AI Skills Gap Analysis

In Demand Job Role



Chip Designer



RTL Design Engineer



ASIC Verification Engineer



FPGA Design Engineer



Physical Design Engineer



DFT Engineer



Analog IC Design Engineer



Embedded Firmware Engineer

Current Core Skill Sets

Digital design, SoC architecture, Verilog/VHDL, System-level design

Verilog/VHDL, SystemVerilog, simulation tools (ModelSim, Questa), synthesis (Synopsys DC)

UVM/OVM, SystemVerilog, functional coverage, constrained-random verification

VHDL/Verilog, FPGA toolchains (Xilinx Vivado, Intel Quartus), timing closure

Place & Route (Innovus, ICC2), STA, clock tree synthesis, floorplanning

Scan insertion, ATPG, BIST, JTAG, fault modeling

SPICE simulation, Op-amp design, ADC/DAC, PLL

C/C++, RTOS, device drivers, microcontroller programming

Emerging AI-Driven Skill Sets

AI accelerator architecture, ML model-to-silicon optimization, tensor processing unit (TPU) design, dataflow modeling

AI workload-specific RTL optimization, hardware-aware ML compilers, ML-based synthesis and verification tools

ML-driven test generation, AI-based coverage closure, reinforcement learning for verification planning

AI inference on FPGA, ML accelerator IP integration, quantization-aware design, edge AI pipeline optimization

AI-based EDA for P&R, ML-driven timing and power optimization, predictive DRC/LVS closure

AI-driven test pattern generation, ML for fault prediction and yield improvement, adaptive test flows

AI-assisted analog circuit synthesis, ML for parametric yield optimization, AI in mixed-signal co-simulation

Embedded AI (TinyML), on-device inference optimization, AI-based firmware diagnostics

In Demand Tech Job Roles Across The Top Companies

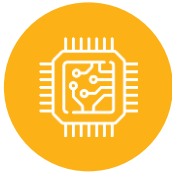
High-Demand Role(s)	Key Drivers
Principal Engineer, IP Design	Roughly four in ten engineers are aligned to automotive/edge programs, which concentrates leadership demand in IP design; senior principals are pulled in to mentor and unblock teams as staffing for new platforms rises by about a third year over year.
Digital Design Engineer, Data Integration Engineer	About one in three technical FTEs are directly on front-end design and integration; program starts have outpaced internal mobility by ~20%, creating persistent openings for digital design and data integration to close schedule risk on multi-die programs.
Advanced Modelling Engineer, Firmware Engineer	Around a third of engineering effort sits in firmware, modelling, and validation for controllers; as device complexity steps up each node, modelling hours grow by low-to-mid-teens annually, pulling incremental demand for advanced modelling and embedded FW talent.
Algorithm Developer, HPC Architect	Roughly one in five technical roles are pointed at computational R&D and factory optimization; algorithm teams see workload growth in the high-teens, and HPC architects are staffed early to reduce tool-time variability, lifting demand for senior hires.
Deep Learning Engineer, Senior AI Engineer	More than half of R&D headcount is concentrated in AI software stacks and platform enablement; library and frameworks work expands faster than general software by ~2x, creating sustained need for deep learning and senior AI engineers to scale developer velocity.
Silicon Validation Engineer, SoC Design Engineer	Validation consumes between half and ~70% of total chip engineering hours depending on program phase; schedule compression has shifted ~10% more effort left into pre-silicon, increasing openings in silicon validation and SoC design to de-risk tape-outs.
Solutions Lead, Physical Design Engineer	Physical design teams operate near full utilization while low-power targets tighten by high single digits; with solutions teams covering cross-BU integrations, lead-level roles expand by low-teens to absorb partner asks and platform variants.
EDA Tool Engineers, IP Verification	Roughly six in ten employees are in engineering, and verification-related requisitions consistently represent a large share of open roles; rising SoC complexity adds mid-teens growth in verification staffing needs, sustaining demand for EDA and IP-V experts.
Verification Engineer, SoC Engineer	Close to seven in ten engineering hours on large programs are spent on verification when you include DV, formal, and regression; as AI-centric designs scale teams by low-teens, verification and SoC headcount grows proportionally to protect first-silicon success.

SEMICONDUCTOR GCC FOOTPRINT & EVOLUTION IN INDIA



Semiconductor GCC Footprint & Evolution in India

India has become the **world's most strategic location for semiconductor Global Capability Centers (GCCs)** – combining **scale, breadth, and innovation readiness**.



55+ GCCs, 95+ physical sites, and 60,000+ engineers make India one of the **largest semiconductor talent hubs outside the US**.



These centers are no longer “cost arbitrage engines.” They are increasingly **owning IP-critical design charters, piloting AI-led workflows, and co-creating next-gen silicon architectures** with HQ teams.



With **global semiconductor supply chains under geopolitical stress** (US–China tech rivalry, Taiwan dependence, EU/US CHIPS Acts), India’s GCC footprint represents a **resilient node for talent, design, and downstream ATMP integration**.








City Distribution of GCC Workforce

City	% of GCC Workforce	Strategic Positioning
Bengaluru	58%	Epicenter for global R&D; deepest end-to-end design + verification pipelines. But attrition + wage inflation create fragility.
Hyderabad	23%	Fastest-scaling hub; strong in EDA tools, SoC verification, AI-first design; emerging as “Next Bengaluru.”
Delhi NCR	7%	EDA + embedded hub, proximity to IIT Delhi talent pipeline.
Tier-2 (Ahmedabad, Mohali, Thiruvananthapuram, Pune)	~12%	Policy-backed nodes: ATMP, auto-electronics, embedded systems. Future scalability for cost + resilience.

Additional Insight: India’s GCCs are highly concentrated, **80%+ workforce in just two cities (BLR + HYD)**. Firms that diversify into Tier-2 hubs early will **de-risk attrition exposure** and **lock in policy incentives**.

GCC Evolution: From Deterministic to AI-First

India's GCCs have rapidly transitioned from **deterministic design support** → to **AI-augmented, IP-owning co-innovation hubs**.

Workflow	Pre-2020 (Support Era)	2025+ (AI-First Era in India)
 SoC Architecture	Block integration, RTL tuning	30% of new SoCs integrate AI/ML accelerators ; chiplets + NoC mainstream.
 SoC Design	RTL-to-GDS on monolithic dies	30%+ moving to 5–7nm nodes ; multi-die integration; India teams co-own tape-out paths.
 Verification	Manual stimulus, regression farms	50% of JDs now mandate UVM + ML-driven coverage closure ; Python-based automation mainstream.
 Physical Design	Floor planning, static scripts	20-30% GCC flows now AI-assisted P&R, ML-driven timing closure .
 Analog IC Design	SPICE simulation, manual corner analysis	~20% projects use ML-aided yield optimization, AI-driven corner exploration .
 Firmware / Embedded	Bare-metal RTOS bring-up	15-20% GCC charters now demand TinyML, cybersecurity stacks, OTA upgrades .
 EDA Tool Dev.	Deterministic algorithms	30-40% teams building AI-enabled EDA flows ; GPU-accelerated solvers.

Additional Insight: For global HQs, India GCCs are no longer about “offshoring”, they are **frontline sites for AI adoption in chip design**. This is where **EDA innovation and AI-first workflows are tested, scaled, and institutionalised**.

What This Means for Global Semiconductor Organizations



India is the innovation multiplier

GCCs are where **AI-first chip design gets industrialized**. Scaling India teams means faster adoption of ML-driven verification, AI-based P&R, and on-device AI firmware.



De-risking global supply chains

With Taiwan's concentration a systemic risk, India GCCs + ATMP initiatives (Micron Gujarat) provide **geopolitical hedging and downstream resilience**.



Leadership talent gap is the next bottleneck

India has execution depth but a **thin leadership bench** in Analog, Power Discretes, and advanced EDA.



City diversification is an imperative, not an option

- **Today:** BLR + HYD = 80%+ of workforce.
- **Tomorrow:** GCCs must anchor Tier-2 nodes (Ahmedabad, Mohali, Thiruvananthapuram) to secure talent resilience + cost advantage + policy subsidies.

COMPENSATION TRENDS



Prominent Compensation Trends

Role-wise Compensation Bands – (4–8 Years)

Role	Bengaluru	Hyderabad	Delhi NCR
SoC Architect	50 – 85L	48 – 80L	47 – 78L
SoC Design Engineer	28 – 45L	27 – 43L	26 – 42L
ASIC Verification Engineer	24 – 40L	23 – 38L	22 – 37L
Verification Engineer	23 – 36L	22 – 35L	21 – 34L
Analog IC Design Engineer	25 – 45L	24 – 43L	23 – 42L
Embedded Firmware Engineer	18 – 28L	17 – 26L	16 – 25L
Embedded Software Engineer	17 – 26L	16 – 24L	15 – 23L
Chip Designer	32 – 50L	31 – 48L	30 – 47L

Premium clusters leading pay bands

- Top compensation is concentrated in SoC Architects, Senior SoC Design, and Analog IC roles, reflecting high demand for complex IP work. Mid-premium ranges are anchored by ASIC Verification, while Embedded Software and Firmware sit at the lower end. This creates a clear tiering of pay scales across job families.

Near-term outlook (2–3 quarters)

- High-scarcity roles such as SoC Architect and Analog IC are expected to see 5–6% salary growth in the near term. Physical, DFT, and Verification roles should firm up by 3-4%. Equity and RSUs will remain key levers to attract and retain VLSI and SoC design talent.

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